

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	63007	(lead electrode (electrical adj contacts)).clm.	US-PGPUB	OR	OFF	2005/07/15 17:08
L2	27627	(polish resistance).clm.	US-PGPUB	OR	OFF	2005/07/15 17:09
L3	55183	(layers! or films! or ((second upper) adj (layer film))).clm.	US-PGPUB	OR	OFF	2005/07/15 17:09
L4	1049	1 and 2 and 3	US-PGPUB	OR	OFF	2005/07/15 17:09
L5	31	(polish and resistance).clm.	US-PGPUB	OR	OFF	2005/07/15 17:12
L6	7	1 and 3 and 5	US-PGPUB	OR	OFF	2005/07/15 17:10

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L6	7	1 and 3 and 5	US-PGPUB	OR	OFF	2005/07/15 17:10
L7	255	(360/322).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/15 17:14
L8	259	(360/313).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/15 17:14
L9	1469	(360/110).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/15 17:14
L10	1974	L7 L8 L9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/15 17:14
L11	15	10 and @PD>"20050601"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/15 17:15
S1	251	(360/322).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 21:44
S2	258	(360/313).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 21:44

S3	1466	(360/110).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 21:45
S4	1966	S1 S2 S3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 12:17
S5	29171	second adj electrodes!	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:18
S6	3473	second adj leads!	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:18
S7	273591	hardness	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:18
S8	711	polishing near2 resistance	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:19
S9	9225	additional with conductors	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:19
S10	177989	("360"/\$ "369"/\$ "720"/\$ 29/603\$).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:19
S11	190	S5 and S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:19
S12	353	S6 and S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:19

S13	19	S8 and S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:19
S14	96	S9 and S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:19
S15	653	S11 S12 S13 S14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:51
S16	2290	S7 and S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:20
S17	10	S16 and (S11 S12 S14)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:33
S18	193283	bilayer multilayer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:33
S19	4743302	lead electrode contact	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:33
S20	6329	S18 near3 S19	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:33
S21	127	S10 and S20	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:33
S22	549554	etch\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:51

S23	279212	polish\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:52
S24	4845654	resist\$5 rate rates	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:52
S25	88104	(S22 S23) near2 S24	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:52
S26	10792	S19 with S25	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:53
S27	1037376	recess\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:53
S28	399	S26 same S27	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:53
S29	89	S10 and S26	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/13 22:53
S30	1	"6813121".pn.	US-PGPUB; USPAT	OR	OFF	2005/06/15 10:23

S31	23	(US-20020055307-\$ or US-20020093773-\$ or US-20030053265-\$ or US-20030058587-\$ or US-20040004788-\$ or US-20040008455-\$ or US-20040027731-\$ or US-20040062152-\$ or US-20040095691-\$ or US-20050024782-\$).did. or (US-5491600-\$ or US-5680282-\$ or US-5883764-\$ or US-6176005-\$ or US-6209193-\$ or US-6219207-\$ or US-6501626-\$ or US-6570743-\$ or US-6760966-\$ or US-6783874-\$ or US-6785101-\$ or US-6798622-\$ or US-6813121-\$).did.	US-PGPUB; USPAT	OR	OFF	2005/06/15 11:58
S32	49	("6222586" "6222586" "5486968" "5761013" "4287572" "4370590" "4450553" "4998239" "5001692" "5016240" "5268806" "5557492" "5686721" "5729021" "5737287" "5798903" "5910885" "5953306" "6119517" "6128211" "6195871" "4357685" "4419836" "4541026" "4769802" "4914503" "4923574" "4949332" "4962415" "5025435" "5235280" "5337939" "5448068" "5467881" "5491600" "5535079" "5568335" "5620766" "5731937" "5739990" "5783460" "5872739" "5923488" "5946286" "6011762" "6021173" "6078643" "6160687" "6176005" "6190974").pn.	US-PGPUB; USPAT	OR	OFF	2005/06/15 12:16
S33	254	(360/322).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 12:17
S34	260	(360/313).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 12:17
S35	1468	(360/110).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 12:17
S36	1973	S33 S34 S35	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/15 17:14